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SMP-0SCMC

Trisil™ for telecommunication equipment protection

Datasheet - production data

Features

- Bidirectional crowbar protection
- Repetitive peak pulse current (T_{amb} -40 °C to +85 °C)
 - I_{PP} = 100 A (10/1000 µs)
 - I_{PP} = 200 A (5/310 µs)
 - I_{PP} = 500 A (2/10 μ s)
- Breakdown voltage: from 72 V to 310 V
- Operating T_i max: 150 °C
- Micro capacitance technology
- JEDEC registered package outline

Complies with the following standards

- Telcordia GR-1089
- ITU-T K20/21/45 enhanced level
- TIA-968
- YD/T 950 / 993 / 1082
- IEC 61000-4-5
- IEC 61000-4-2 level 4
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)
- MIL STD 883H Method 3015-8 Class 3B
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 soldererabilty
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint
- UL497B recognized, UL file E136224



Description

The devices in the SMP-0SCMC series are micro capacitance Trisils designed to protect broadband telecommunication equipment such as DSL modems, subscriber gateways and DSLAMs from lightning surges and power faults.

Trisils are not subject to aging and provide a failsafe mode in short circuit for a better protection. They are used to help equipment to meet main standards such as UL60950, IEC950 / CSA C22.2and UL1459.

The SMP-0SCMC series is packaged in SMB.

TM: Trisil is a trademark of STMicroelectronics

Characteristics SMP-0SCMC

1 Characteristics

Table 1. Absolute ratings (-40 $^{\circ}$ C < T_{amb} < 85 $^{\circ}$ C) for repetitive peak pulse current I_{PP}

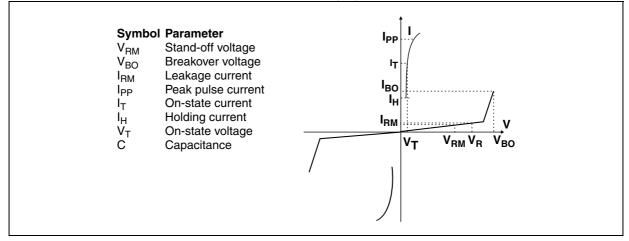
		_		aiiio						
Voltage pulse	0.5/700	2/10	1.2/50	10/160	10/560	9/720	10/360	10/1000	10/700	μs
Current pulse	0.2/310	2/10	8/20	10/160	10/560	5/320	10/360	10/1000	5/310	μs
I _{PP}	100	500	400	200	150	200	175	100	200	Α

Table 2. Absolute ratings ($T_{amb} = 25$ °C) for other parameters

Symbol	Parameter	Value	Unit	
		t = 10 ms t = 0.2 s	61 18	
I _{TSM}	Non repetitive surge peak on-state current (sinusoidal) ⁽¹⁾	t = 1 s t = 2 s	9	Α
		7		
		t = 15 mn	4	
T _{stg}	Storage temperature range	-55 to 150	°C	
T _j	Operating junction temperature range	-40 to 150	°C	
T_L	Maximum lead temperature for soldering during 10 s.	260	°C	

^{1.} In fail safe mode, the device acts as a short circuit.

Figure 1. Electrical characteristics - definitions ($T_{amb} = 25$ °C)



SMP-0SCMC Characteristics

Table 3. Electrical characteristics - values ($T_{amb} = 25$ °C)

	I _{RM} max	« V _{RM}	V_{BR}	V _{BO}	I _H	V _T @ 2.2 A	C @ 2 V	C @ 50 V	α Τ⁽¹⁾
Order code	Max.		Тур.	Max.	Min.	Max.	Max.	Max.	
	μΑ	v	V	v	mA	v	pF	pF	10 ⁻⁴ /°C
SMP0720SCMC	5	65	72	88	150	3	80	45	9
SMP0900SCMC	5	75	90	98	150	3	80	45	9.1
SMP1100SCMC	5	90	110	130	150	3	75	40	9.3
SMP1300SCMC	5	120	130	160	150	3	75	40	9.5
SMP1500SCMC	5	140	150	180	150	3	75	40	9.7
SMP1800SCMC	5	170	180	220	150	3	70	35	9.9
SMP2100SCMC	5	180	210	240	150	3	45	25	10.2
SMP2300SCMC	5	190	230	260	150	3	45	25	10.3
SMP2600SCMC	5	220	260	300	150	3	40	20	10.6
SMP3100SCMC	5	275	310	350	150	3	40	20	11

^{1.} For V_{BR} versus junction temperature, use the following formula: V_{BR} @ $T_J = V_{BR}$ @ 25 °C x (1 + αT x (T_J - 25))

Figure 2. Pulse waveform

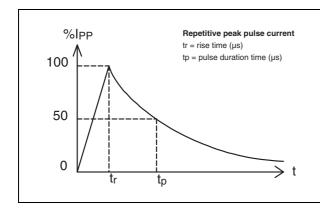
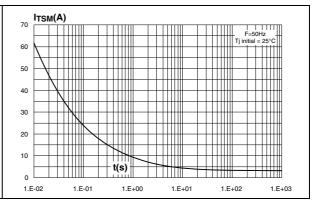


Figure 3. Non repetitive surge peak on-state current versus overload duration

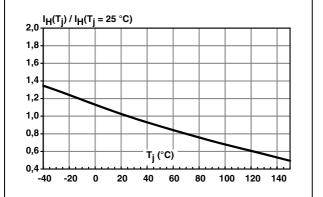


Characteristics SMP-0SCMC

Figure 4. Relative variation of holding current versus junction temperature

4/7

Figure 5. Percentage of change of break over voltage versus junction temperature



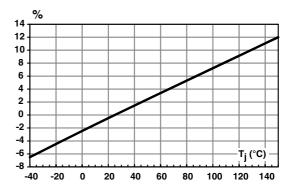
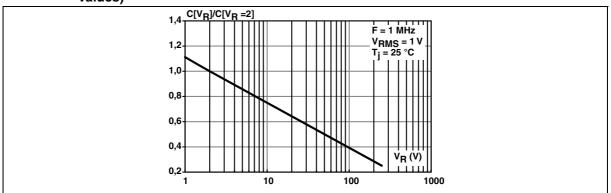


Figure 6. Relative variation of junction capacitance versus reverse applied voltage (typical values)



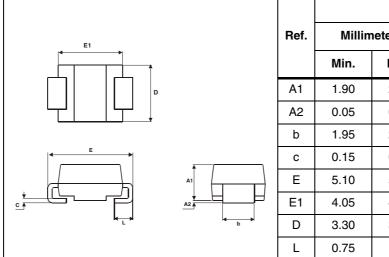
SMP-0SCMC Package information

2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

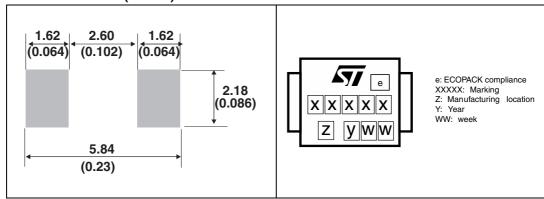
Table 4. SMB dimensions



	Dimensions							
Ref.	Millim	neters	Inches					
	Min.	Max.	Min.	Max.				
A1	1.90	2.45	0.075	0.096				
A2	0.05	0.20	0.002	0.008				
b	1.95	2.20	0.077	0.087				
С	0.15	0.40	0.006	0.016				
Е	5.10	5.60	0.201	0.220				
E1	4.05	4.60	0.159	0.181				
D	3.30	3.95	0.130	0.156				
L	0.75	1.50	0.030	0.059				

Figure 7. Footprint dimensions in mm (inches)

Figure 8. Marking layout



Ordering information SMP-0SCMC

3 Ordering information

 Table 5.
 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SMP0720SCMC	P07CM				
SMP0900SCMC	P09CM				
SMP1100SCMC	P11CM				
SMP1300SCMC	P13CM				
SMP1500SCMC	P15CM	SMB	00 ma	2500	Tana and roal
SMP1800SCMC	P18CM	SIVID	98 mg	2500	Tape and reel
SMP2100SCMC	P21CM				
SMP2300SCMC	P23CM				
SMP2600SCMC	P26CM				
SMP3100SCMC	P31CM				

4 Revision history

Table 6. Document revision history

Date	Revision	Changes
17-Jan-2013	1	Initial version.

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